



CS116160ET1

主要参数 MAIN CHARACTERISTICS

$I_{T(AV)}$	116A
V_{DRM}/V_{RRM}	1600V
I_{GT}	150mA

用途

- 直流电机控制
- 软启动交流电机控制
- 光、热温度控制

产品特性

- 台面终端芯片, 高可靠性和一致性
- 环保 RoHS 产品

APPLICATIONS

- DC motor control
- Softstart AC motor controller
- Light, heat and temperature control

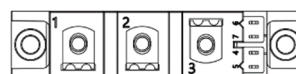
FEATURES

- Glass-passivated mesa chip for reliability and uniform
- RoHS products

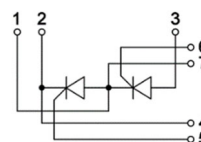
封装 Package



外形示意图



引脚示意图



电路示意图

订货信息 ORDER MESSAGES

订货型号 Order codes	印记 Marking	封装 Package
无卤-散装 Halogen-Free-Bulk		
CS116160ET1-ET1-FR	CS116160ET1	ET1

绝对最大额定值ABSOLUTE RATINGS($T_c=25^\circ\text{C}$)

Symbol	Test Conditions	Maximum Ratings	Unit	
I_{TRMS}, I_{FRMS}	$T_{VJ}=T_{VJM}$	180	A	
I_{TAVM}, I_{FAVM}	$T_c=85^\circ\text{C}; 180^\circ$ sine	116		
I_{TSM}, I_{FSM}	$T_{VJ}=45^\circ\text{C}$ $V_R=0$ $t=10\text{ms}$ (50Hz), sine	2250	A	
	$T_{VJ}=T_{VJM}$ $V_R=0$ $t=8.3\text{ms}$ (60Hz), sine	2400		
$\int i^2 dt$	$T_{VJ}=45^\circ\text{C}$ $V_R=0$ $t=10\text{ms}$ (50Hz), sine	25300	A ² s	
	$T_{VJ}=T_{VJM}$ $V_R=0$ $t=8.3\text{ms}$ (60Hz), sine	23900		
$(di/dt)_{cr}$	$T_{VJ}=T_{VJM}$ $f=50\text{Hz}, t_p=200\mu\text{s}$ $V_D=2/3V_{DRM}$ $I_G=0.45\text{A}$ $di_G/dt=0.45\text{A}/\mu\text{s}$	repetitive, $I_T=250\text{A}$ non repetitive, $I_T=I_{TAVM}$	150	A/ μs
			500	
$(dv/dt)_{cr}$	$T_{VJ}=T_{VJM};$ $R_{GK}=$; method 1 (linear voltage rise)	$V_{DR}=2/3V_{DRM}$ 1000	V/ μs	
P_{GM}	$T_{VJ}=T_{VJM}$ $t_p=30\mu\text{s}$	10	W	
	$I_T=I_{TAVM}$ $t_p=300\mu\text{s}$	5		
P_{GAV}		0.5	W	
V_{RGM}		10	V	
T_{VJ}		-40...+125	$^\circ\text{C}$	
T_{VJM}		125		
T_{stg}		-40...+125		
V_{ISOL}	50/60Hz, RMS $I_{ISOL}\leq 1\text{mA}$	$t=1\text{min}$ $t=1\text{s}$	3000 3600	V~
M_d	Mounting torque (M5)	2.5-4.0/22-35	Nm/lb.in.	
	Terminal connection torque (M5)	2.5-4.0/22-35		
Weight	Typical including screws	82	g	



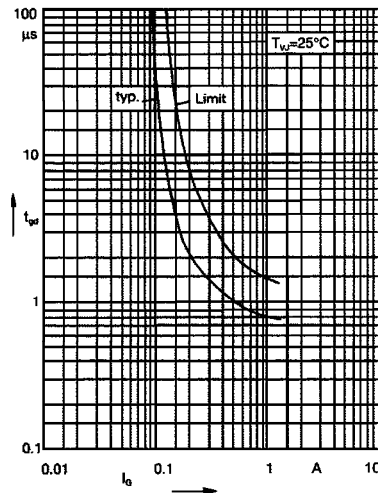
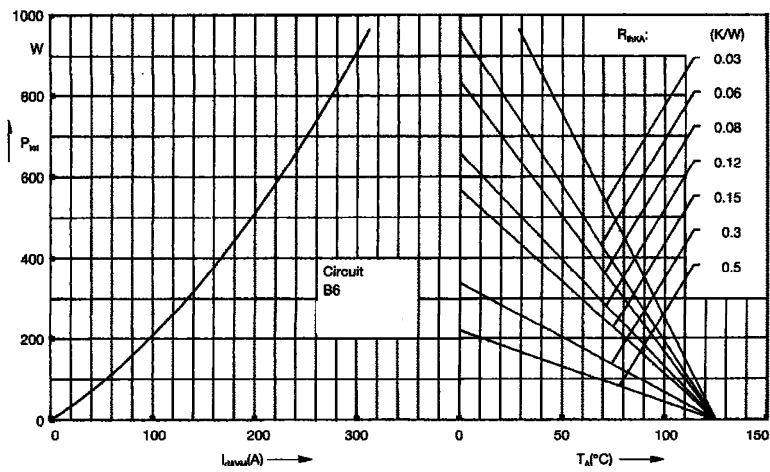
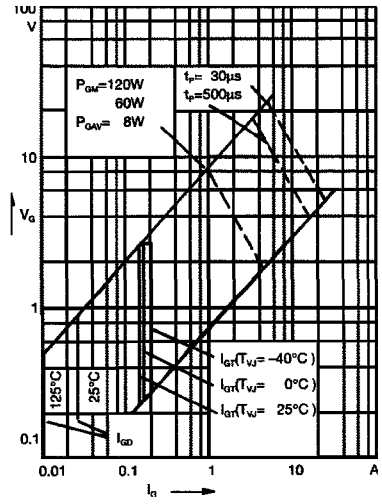
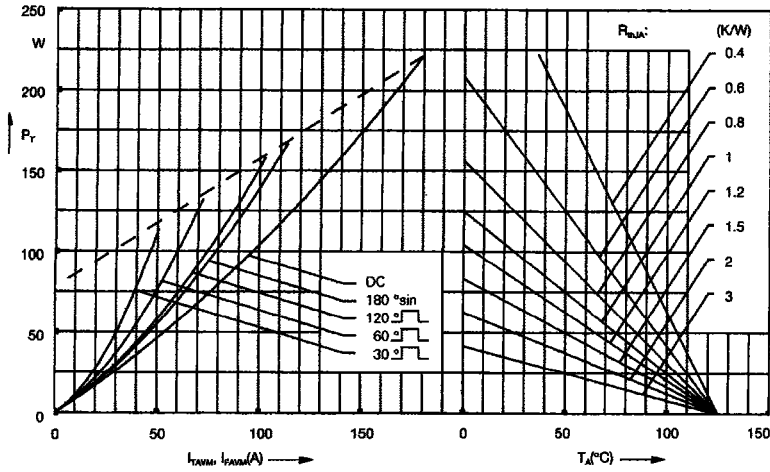
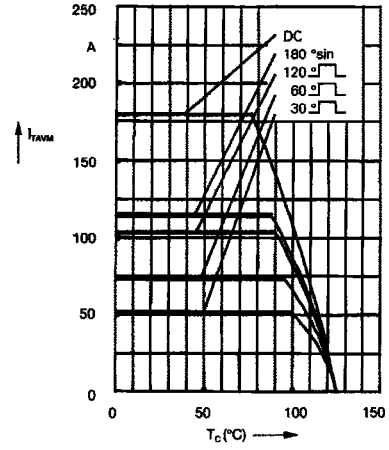
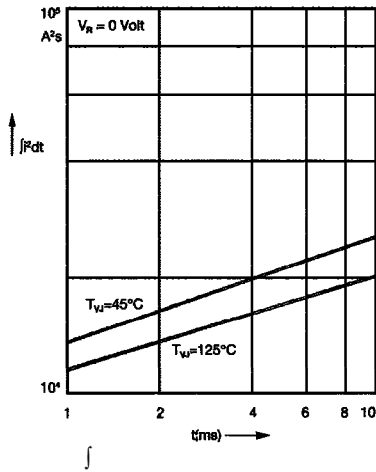
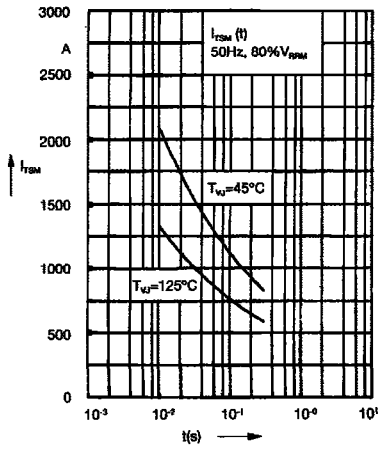
电特性 ELECTRICAL CHARACTERISTIC ($T_c=25^\circ\text{C}$)

Symbol	Test Conditions	Characteristic Values	Unit
I_{RRM}, I_{DRM}	$T_{VJ}=T_{VJM}; V_R=V_{RRM}; V_D=V_{DRM}$	20	mA
V_T, V_F	$I_T, I_F=300\text{A}; T_{VJ}=25^\circ\text{C}$	1.65	V
V_{TO}	For power-loss calculations only ($T_{VJ}=125^\circ\text{C}$)	0.8	V
r_T		2.4	m
V_{GT}	$V_D=6\text{V}; T_{VJ}=25^\circ\text{C}$ $T_{VJ}=-40^\circ\text{C}$	2.5 2.6	V
I_{GT}	$V_D=6\text{V}; T_{VJ}=25^\circ\text{C}$ $T_{VJ}=-40^\circ\text{C}$	150 200	mA
V_{GD}	$T_{VJ}=T_{VJM}; V_D=2/3V_{DRM}$	0.2	V
I_{GD}		10	mA
I_L	$T_{VJ}=25^\circ\text{C}; t_p=10\mu\text{s}; V_D=6\text{V}$ $I_G=0.45\text{A}; di_G/dt=0.45\text{A}/\mu\text{s}$	450	mA
I_H	$T_{VJ}=25^\circ\text{C}; V_D=6\text{V}; R_{GK}=\text{---}$	200	mA
t_{gd}	$T_{VJ}=25^\circ\text{C}; V_D=1/2V_{DRM}$ $I_G=0.45\text{A}; di_G/dt=0.45\text{A}/\mu\text{s}$	2	μs
t_q	$T_{VJ}=T_{VJM}; I_T=150\text{A}; t_p=200\mu\text{s}; -di/dt=10\text{A}/\mu\text{s}$ typ. $V_R=100\text{V}; dv/dt=20\text{V}/\mu\text{s}; V_D=2/3V_{DRM}$	185	μs
Q_s	$T_{VJ}=T_{VJM}; I_T, I_F=50\text{A}; -di/dt=6\text{A}/\mu\text{s}$	170	μC
I_{RM}		45	A
R_{thJC}	per thyristor/diode; DC current per module	0.22 0.11	K/W
R_{thJK}	per thyristor/diode; DC current per module	0.42 0.21	K/W
d_s	Creeping distance on surface	12.7	mm
d_A	Strike distance through air	9.6	mm
a	Maximum allowable acceleration	50	m/s^2





特征曲线ELECTRICAL CHARACTERISTICS (curves)





特征曲线ELECTRICAL CHARACTERISTICS (curves)

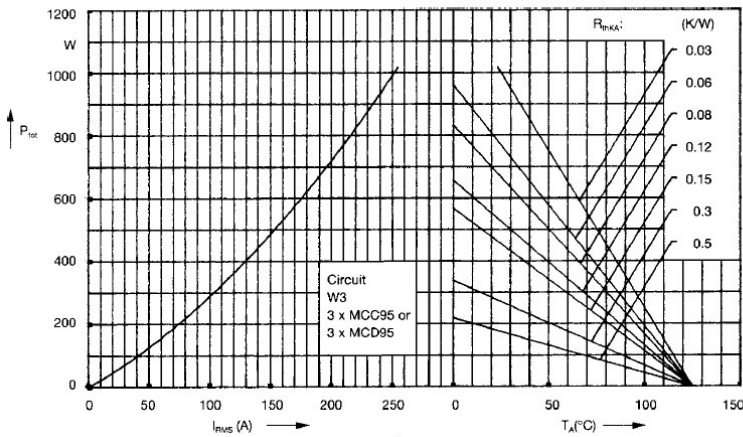


Fig. 7 Three phase AC-controller: Power dissipation versus RMS output current and ambient temperature

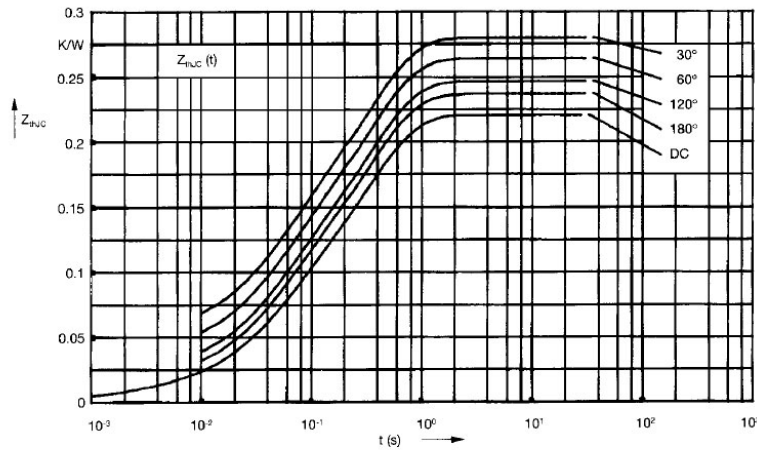


Fig. 8 Transient thermal impedance junction to case (per thyristor or diode)

R_{thJC} for various conduction angles d:

d	R_{thJC} (K/W)
DC	0.22
180°	0.23
120°	0.25
60°	0.27
30°	0.28

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0066	0.0019
2	0.0678	0.0477
3	0.1456	0.344

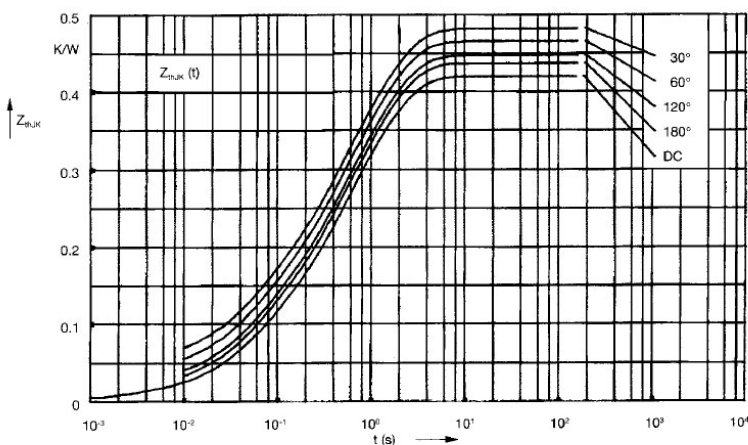


Fig. 9 Transient thermal impedance junction to heatsink (per thyristor or diode)

R_{thJK} for various conduction angles d:

d	R_{thJK} (K/W)
DC	0.42
180°	0.43
120°	0.45
60°	0.47
30°	0.48

Constants for Z_{thJK} calculation:

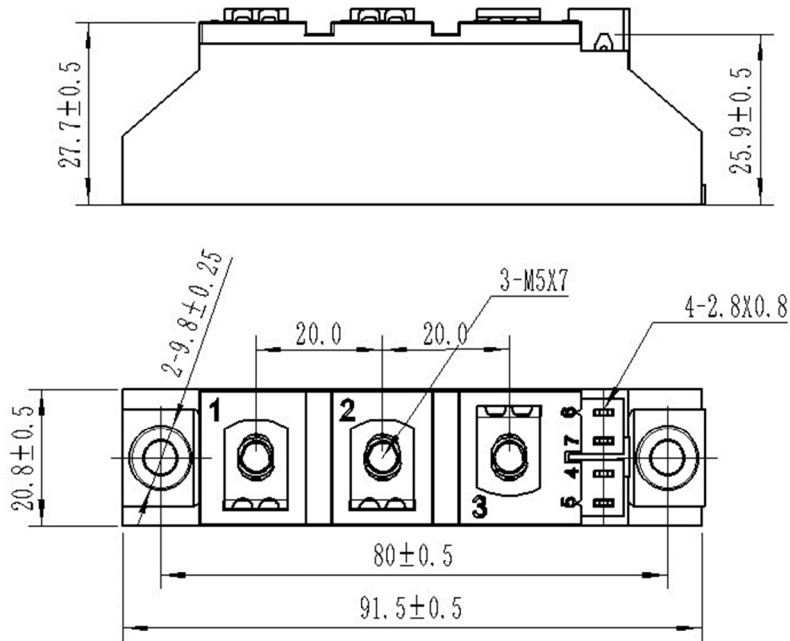
i	R_{thi} (K/W)	t_i (s)
1	0.0066	0.0019
2	0.0678	0.0477
3	0.1456	0.344
4	0.2	1.32



外形尺寸 PACKAGE MECHANICAL DATA

ET1

单位 Unit : mm





注意事项

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3. 在电路设计时请不要超过器件的绝对最大额定值，否则会影响整机的可靠性。
4. 本说明书如有版本变更不另外告知。

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3. Please do not exceed the absolute maximum ratings of the device when circuit designing.
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